



# MJ N-Channel Super Trench Power MOSFET

### Description

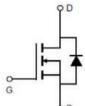
The MJXP1550G uses Super Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of R<sub>DS(ON)</sub> and Q<sub>g</sub>. This device is ideal for high-frequency switching and synchronous rectification.

#### General Features

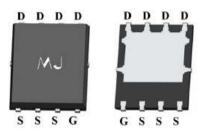
- ♦ Vds=150V,Id=50A Rds(on) <25mΩ @ Vgs=10V
- ◆ Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- ◆ Very low on-resistance R<sub>DS(on)</sub>
- ◆ 150°C operating temperature
- ◆ Pb-free lead plating
- ♦ 100% UIS tested

### Application

- ◆ DC/DC Converter
- ◆ Ideal for high-frequency switching and synchronous rectification







Top View

**Bottom View** 

### 100% UIS TESTED! 100% ΔVds TESTED!

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJXP1550G	MJXP1550G	DFN5X6-8L	2	4	9

### Absolute Maximum Ratings (Tc=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	150	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	ΙD	50	А
Drain Current-Continuous(Tc =100℃)	<b>I</b> D(100℃)	35.4	А
Pulsed Drain Current	Ідм	200	А
Maximum Power Dissipation	Po	125	W
Derating factor		1	W/°C
Single pulse avalanche energy (Note 5)	Eas	210	mJ
Operating Junction and Storage Temperature Range	Тл,Тѕтс	-55 To 150	°C

#### Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rөjc	1	°C/W
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# Electrical Characteristics (Tc=25℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	'					
Drain-Source Breakdown Voltage	BVoss	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	150	_	_	V
Zero Gate Voltage Drain Current	loss	V <sub>DS</sub> =150V,V <sub>GS</sub> =0V	-	-	1	μΑ
Gate-Body Leakage Current	lgss	V <sub>DS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)	'					
Gate Threshold Voltage	VGS(th)	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA	2.5	-	4.5	V
Drain-Source On-State Resistance	Rds(on)	V <sub>GS</sub> =10V,I <sub>D</sub> =30A	-	21	25	mΩ
Forward Transconductance	grs	V <sub>DS</sub> =10V,I <sub>D</sub> =30A	-	40	-	S
Dynamic Characteristics (Note 4)					ı	ı
Input Capacitance	Clss		-	5000	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =75V,V <sub>GS</sub> =0V F=1.0MHz	-	192	-	PF
Reverse Transfer Capacitance	Crss		-	9.5	-	PF
Switching Characteristics (Note 4)					ı	
Turn-on Delay Time	t <sub>d(on)</sub>		-	21	-	nS
Turn-on Rise Time	tr	Vdd=75V,Id=30A	-	20	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	V <sub>GS</sub> =10V,R <sub>G</sub> =4.7Ω	-	40	-	nS
Turn-Off Fall Time	tr		-	10	-	nS
Total Gate Charge	Qg		-	59.8	-	nC
Gate-Source Charge	Qgs	Vds=75V,ld=30A Vgs=10V	_	28.2	-	nC
Gate-Drain Charge	Q <sub>gd</sub>		-	7.1	-	nC
Drain-Source Diode Characteristics				<u> </u>	I	1
Diode Forward Voltage (Note 3)	VsD	V <sub>GS</sub> =0V,I <sub>S</sub> =30A	-	_	1.2	V
Diode Forward Current (Note 2)	Is		-	-	50	А
Reverse Recovery Time	trr	TJ=25°C, IF=Is	-	58	-	nS
Reverse Recovery Charge	Qrr	di/dt=100A/µs (Note 3)	_	135	_	nC

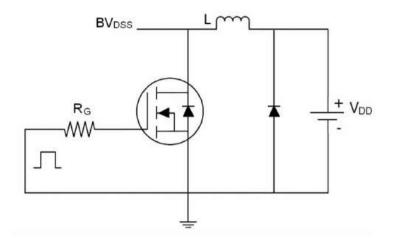
#### Notes:

- 1 Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300 $\mu$ s, Duty Cycle ≤ 2%.
- ④ Guaranteed by design, not subject to production
- $\odot$  EAS condition: Tj=25°C,VDD=50V,VG=10V,L=0.5mH,Rg=25 $\Omega$

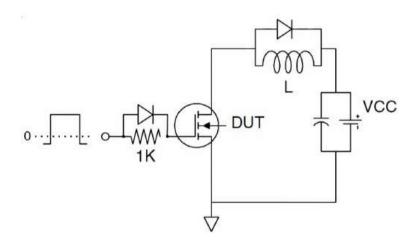




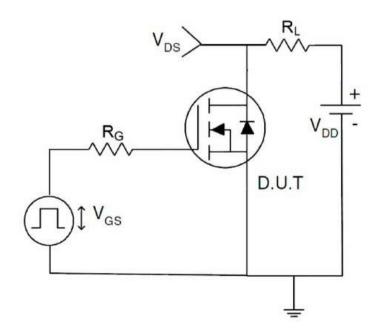
### Test circuit



Eas test Circuit



Gate charge test Circuit

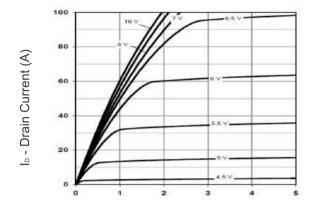


Switch Time Test Circuit



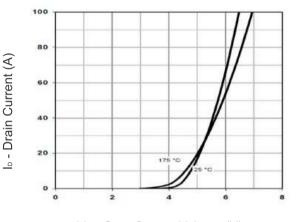


### Typical Electrical and Thermal Characteristics



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

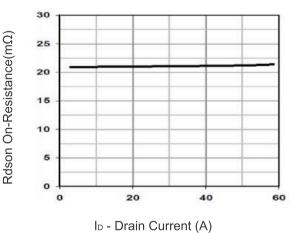
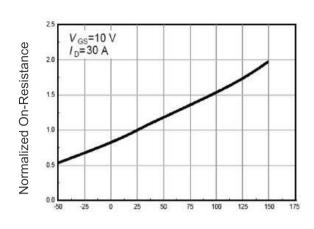


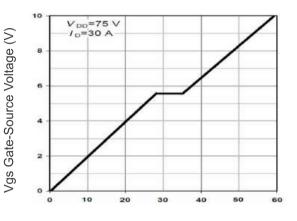
Figure 3 Rdson- Drain Current



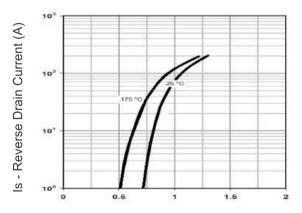
T

J -Junction Temperature(°C)

## Figure 4 Rdson-Junction Temperature



Qg Gate Charge (nC)
Figure 5 Gate Charge

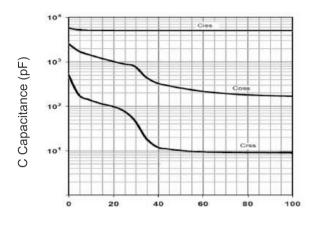


Vsd Source-Drain Voltage (V)

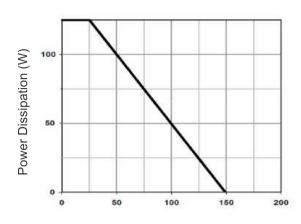
Figure 6 Source- Drain Diode Forward







Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds



T<sub>J</sub> -Junction Temperature(°C) Figure 9 Power De-rating

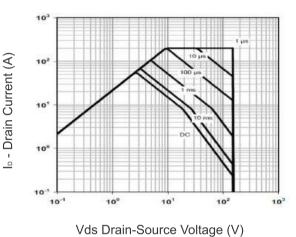
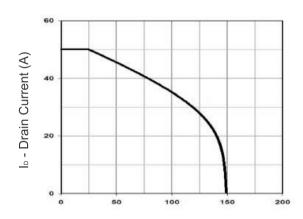
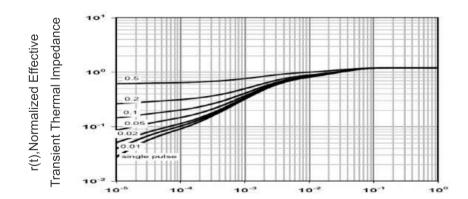


Figure 8 Safe Operation Area



T<sub>J</sub> -Junction Temperature(°C) Figure 10 Current De-rating



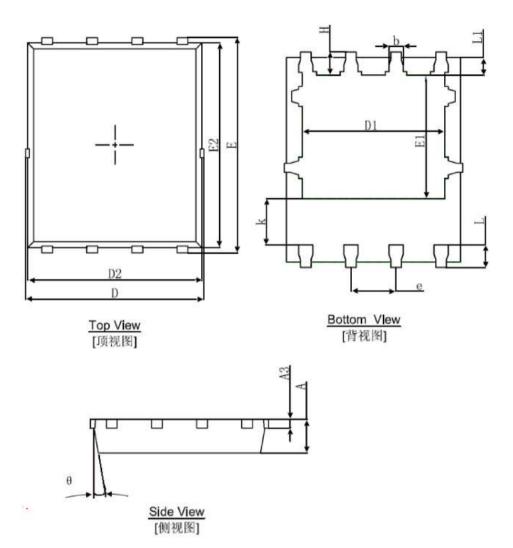
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





# DFN5X6-8L Package Information



Symbol	Dimensions	In Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
Α	0.900	1.000	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
е	1.270	TYP.	0.050	TYP.
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
Н	0.574	0.726	0.023	0.029
θ	8°	12°	8°	12°





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